

QUICKSWITCH[®] PRODUCTS 2.5V / 3.3V 24-BIT BUS EXCHANGE HIGH BANDWIDTH BUS SWITCH

IDTQS3VH16212

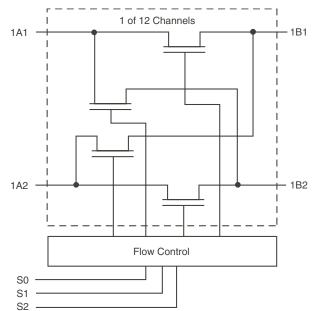
FEATURES:

- N channel FET switches with no parasitic diode to Vcc
 - Isolation under power-off conditions
 - No DC path to Vcc or GND
 - 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- Low Ron 4Ω typical
- · Flat RON characteristics over operating range
- Rail-to-rail switching 0 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- · Excellent RON matching between channels
- Vcc operation: 2.3V to 3.6V
- High bandwidth up to 500 MHz
- LVTTL-compatible control Inputs
- · Undershoot Clamp Diodes on all switch and control Inputs
- Low I/O capacitance, 4pF typical
- Available in TSSOP package

APPLICATIONS:

- · Hot-swapping
- 10/100 Base-T, Ethernet LAN switch
- · Low distortion analog switch
- Replaces mechanical relay
- ATM 25/155 switching

FUNCTIONAL BLOCK DIAGRAM



The IDT logo is a registered trademark of Integrated Device Technology, Inc.

INDUSTRIAL TEMPERATURE RANGE

JANUARY 2013

DESCRIPTION:

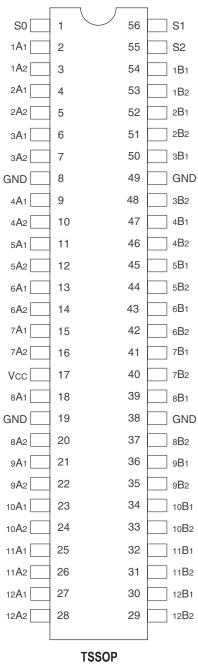
The QS3VH16212 Bus Exchange HotSwitch with 24-bits is a high bandwidth bus switch. The QS3VH16212 has very low ON resistance, resulting in under 250ps propagation delay through the switch. The device operates as a 24-bit bus switch or a 12-bit bus exchanger, which provides data exchanging between the four signal ports through the data-select (So - S2) terminals. In the OFF and ON states, the switches are 5V-tolerant. In the OFF state, the switches offer very high impedence at the terminals.

The combination of near-zero propagation delay, high OFF impedance, and over-voltage tolerance makes the QS3VH16212 ideal for high performance communications applications.

The QS3VH16212 is characterized for operation from -40°C to +85°C.

INDUSTRIAL TEMPERATURE RANGE

PIN CONFIGURATION



TOP VIEW

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max.	Unit
VTERM(2)	Supply Voltage to Ground	-0.5 to 4.6	V
VTERM(3)	DC Switch Voltage Vs	- 0.5 to 5.5	V
VTERM ⁽³⁾	DC Input Voltage VIN	- 0.5 to 5.5	V
VAC	AC Input Voltage (pulse width ≤20ns)	-3	V
Ιουτ	DC Output Current (max. current/pin)	120	mA
Tstg	StorageTemperature	-65 to +150	°C

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc terminals.

3. All terminals except Vcc.

CAPACITANCE ($T_A = +25^{\circ}C$, f = 1MHz, $V_{IN} = 0V$, $V_{OUT} = 0V$)

Symbol	Parameter ⁽¹⁾	Тур.	Max.	Unit
CIN	Control Inputs	3	5	pF
Ci/o	Quickswitch Channels (Switch OFF)	6	8	pF
Cı/o	Quickswitch Channels (Switch ON)	12	16	pF
NOTE:				

1. This parameter is guaranteed but not production tested.

PIN DESCRIPTION

Pin Names	I/O	Description
1Ax - 12Ax	I/O	Bus A
1Bx - 12Bx	I/O	Bus B
S0 - S2	I	DataSelect

FUNCTION TABLE(1)

S 2	S 1	S0	xA 1	xA2	Function
L	L	L	Z	Z	Disconnect
L	L	Н	xB1	Z	xA1 to xB1
L	Н	L	xB2	Z	xA1 to xB2
L	Н	Н	Z	xB1	xA2 to xB1
Н	L	L	Z	xB2	xA2 to xB2
Н	L	Н	Z	Z	Disconnect
Н	Н	L	xB1	xB2	xA1 to xB1, xA2 to xB2
Н	Н	Н	xB2	xB1	xA1 to xB2, xA2 to xB1

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

Z = High-Impedence

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE⁽¹⁾

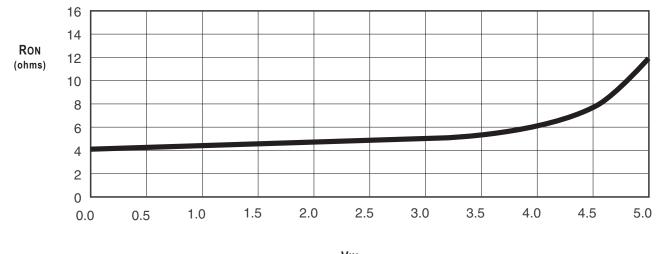
Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40° C to $+85^{\circ}$ C, Vcc = $3.3V \pm 0.3V$

Symbol	Parameter	Test Conditions			Min.	Typ. ⁽¹⁾	Max.	Unit
Vih	Input HIGH Voltage	Guaranteed Logic HI	GH	Vcc = 2.3V to 2.7V	1.7	—	_	V
		for Control Inputs	Γ	Vcc = 2.7V to 3.6V	2	_	_	
VIL	Input LOW Voltage	Guaranteed Logic HI	GH	Vcc = 2.3V to 2.7V	_	—	0.7	V
		for Control Inputs	Γ	Vcc = 2.7V to 3.6V	_	—	0.8	
lin	Input Leakage Current (Control Inputs)	$0V \le V_{IN} \le V_{CC}$		_	—	±1	μA	
loz	Off-State Current (Hi-Z)	$0V \le VOUT \le 5V$, Switches OFF		_	—	±1	μA	
IOFF	Data Input/Output Power Off Leakage	VIN or VOUT OV to 5V	VIN or VOUT 0V to 5V, Vcc = 0V		—	—	±1	μA
		Vcc = 2.3V	VIN = 0V	Ion = 30mA		6	8	
Ron	Switch ON Resistance	(Typ. at Vcc = 2.5V)	VIN = 1.7V	Ion = 15mA	—	7	9	Ω
		Vcc = 3V	VIN = 0V	Ion = 30mA	_	4	6	
			VIN = 2.4V	Ion = 15mA	_	5	8	

NOTE:

1. Typical values are at Vcc = 3.3V and TA = 25°C, unless otherwise noted.

TYPICAL ON RESISTANCE vs VIN AT Vcc = 3.3V



VIN (Volts)

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾	Min.	Тур.	Max.	Unit
lccq	Quiescent Power Supply Current	Vcc = Max., VIN = GND or Vcc, f = 0	—	1.5	3	mA
Δ lcc	Power Supply Current ^(2,3) per Input HIGH	Vcc = Max., VIN = 3V, f = 0 per Control Input	—	—	30	μA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = 3.3V, A and B Pins Open, Control Inputs	See Typical	CCD vs Enable	Frequency gra	ph below
		Toggling @ 50% Duty Cycle				

NOTES:

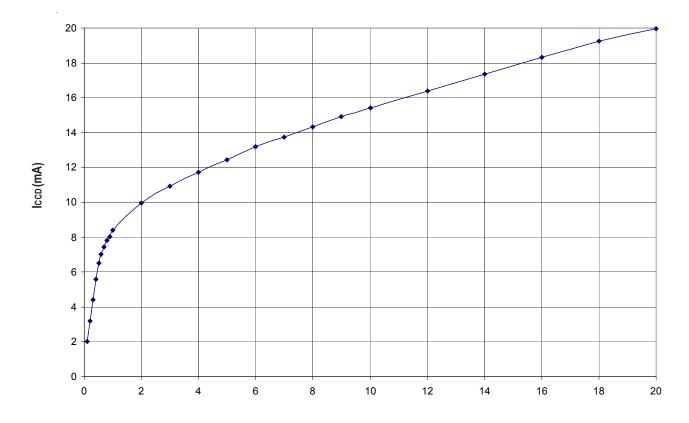
1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Per input driven at the specified level. A and B pins do not contribute to Δ lcc.

3. This parameter is guaranteed but not tested.

4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

TYPICAL ICCD vs ENABLE FREQUENCY CURVE AT Vcc = 3.3V



ENABLE FREQUENCY (MHz)

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$

		$Vcc = 2.5 \pm 0.2 V^{(1)}$		$Vcc = 3.3 \pm 0.3 V^{(1)}$		
Symbol	Parameter	Min. ⁽⁴⁾	Max.	Min. ⁽⁴⁾	Max.	Unit
tPLH	Data Propagation Delay ^(2,3)	—	0.2	—	0.2	ns
t PHL	xAx to xBx or xBx to xAx					
t PZH	Switch Turn-On Delay	1.5	11.5	1.5	11	ns
tPZL	Sx to xAx, xBx					
tPHZ	Switch Turn-Off Delay	1.5	11	1.5	10.5	ns
tPLZ	Sx to xAx, xBx					
tPSX	Propagation Delay	1.5	11	1.5	9	ns
	Sx to xAx, xBx					
fSx	Operating Frequency - Enable ^(2,5)	—	10	—	20	MHz

NOTES:

1. See Test Conditions under TEST CIRCUITS AND WAVEFORMS.

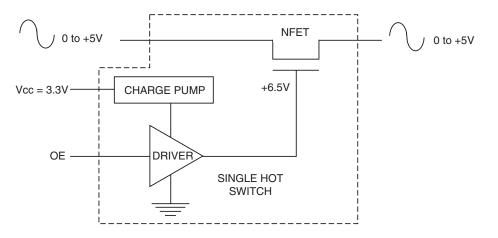
2. This parameter is guaranteed but not production tested.

3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.2ns at CL = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

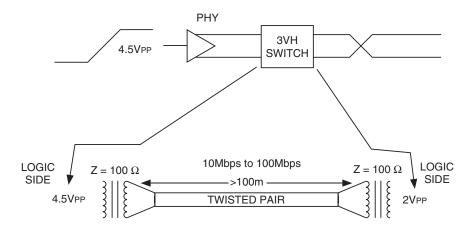
4. Minimums are guaranteed but not production tested.

5. Maximum toggle frequency for Sx control input (pass voltage > Vcc, VIN = 5V, RLOAD \geq 1M Ω , no CLOAD).

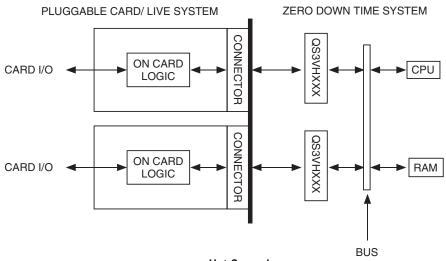
SOME APPLICATIONS FOR HOTSWITCH PRODUCTS



Rail-to-Rail Switching



Fast Ethernet Data Switching (LAN Switch)

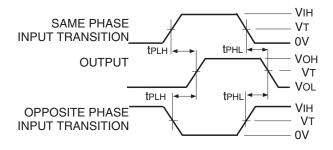


Hot Swapping

TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	$Vcc^{(1)}= 3.3V \pm 0.3V$	$Vcc^{(2)}= 2.5V \pm 0.2V$	Unit
VLOAD	6	2 x Vcc	V
Vih	3	Vcc	V
VT	1.5	Vcc/2	V
Vlz	300	150	mV
VHZ	300	150	mV
CL	50	30	pF





VLOAD/2

Vт

DISABLE

tPLZ|

tPHZ -

Vін

Vт

0V

Vol

Vон

'0V

VLOAD/2

VOL + VLZ

Voh -Vhz

ENABLE

▶ tPZL

→ tPZH

OPEN

CONTROL

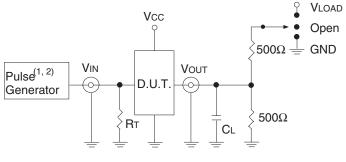
NORMALLY

INPUT

OUTPUT SWITCH NORMALLY CLOSED LOW

OUTPUT SWITCH

HIGH



Test Circuits for All Outputs

DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

NOTES:

- 1. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns.
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2ns; tR \leq 2ns.

SWITCH POSITION

Test	Switch
tplz/tpzL	Vload
tphz/tpzh	GND
tPD	Open

NOTE:

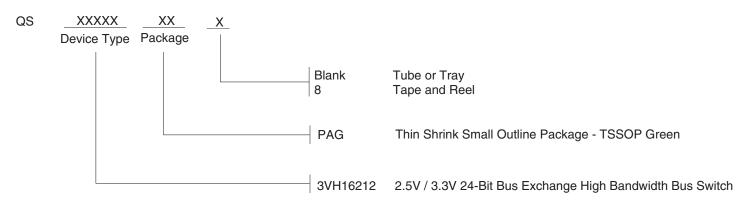
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Vт

0V

Enable and Disable Times

ORDERING INFORMATION



Datasheet Document History

01/31/13

Pg. 1, 8

Updated the Ordering Information by removing non green package version, and Adding Tape and Reel information.

IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: www.renesas.com/contact/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Digital Bus Switch ICs category:

Click to view products by Renesas manufacturer:

Other Similar products are found below :

MT8986AE1 TC7MPB9307FT(EL) MT8985AE1 MT8986AP1 PI3CH800LE PI3C32X384BE ZL50023GAG2 MT8986AL1 MT8981DP1 PI3VT3245-ALE PI3CH800QE MT90823AB1 PI3VT3245-AQE PI3CH800QEX PI3C3384QE PI3C3305UEX PI3B3861QE PI3B3245QEX PI3B3245QE PI3CH1000LE PI3CH401LE PI3CH401LEX TC7WBL3305CFK(5L,F 74CB3Q3125DBQRE4 TC7WBL3305CFK,LF SN74CBT16245CDGGR PI5C3245QE 72V90823PQFG PI3B3861QEX PI3C3126QEX PI3C3245QE PI5C3384QE PI3CH281QE QS3VH16244PAG8 PI3CH400LE PI3B3245LEX PI3B3245LE PI3C3306LEX PI5C3245LEX PI5C3306LEX PI3B3126LE PI3B3125LEX 72V73273BBG 74CBTLV3862PGG QS3126QG QS32245QG QS3244QG QS3245SOG8 QS32X384Q1G QS3VH126QG